



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

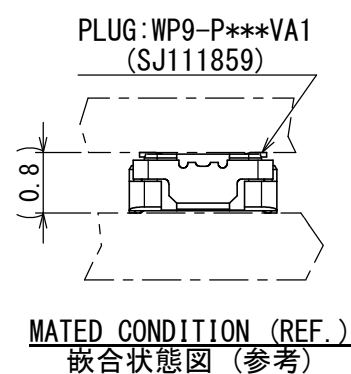
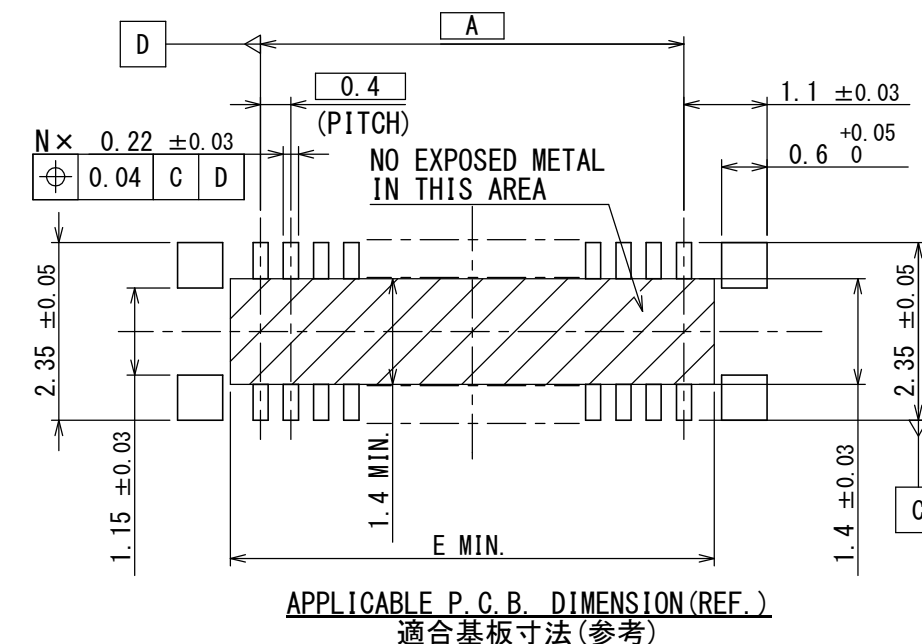
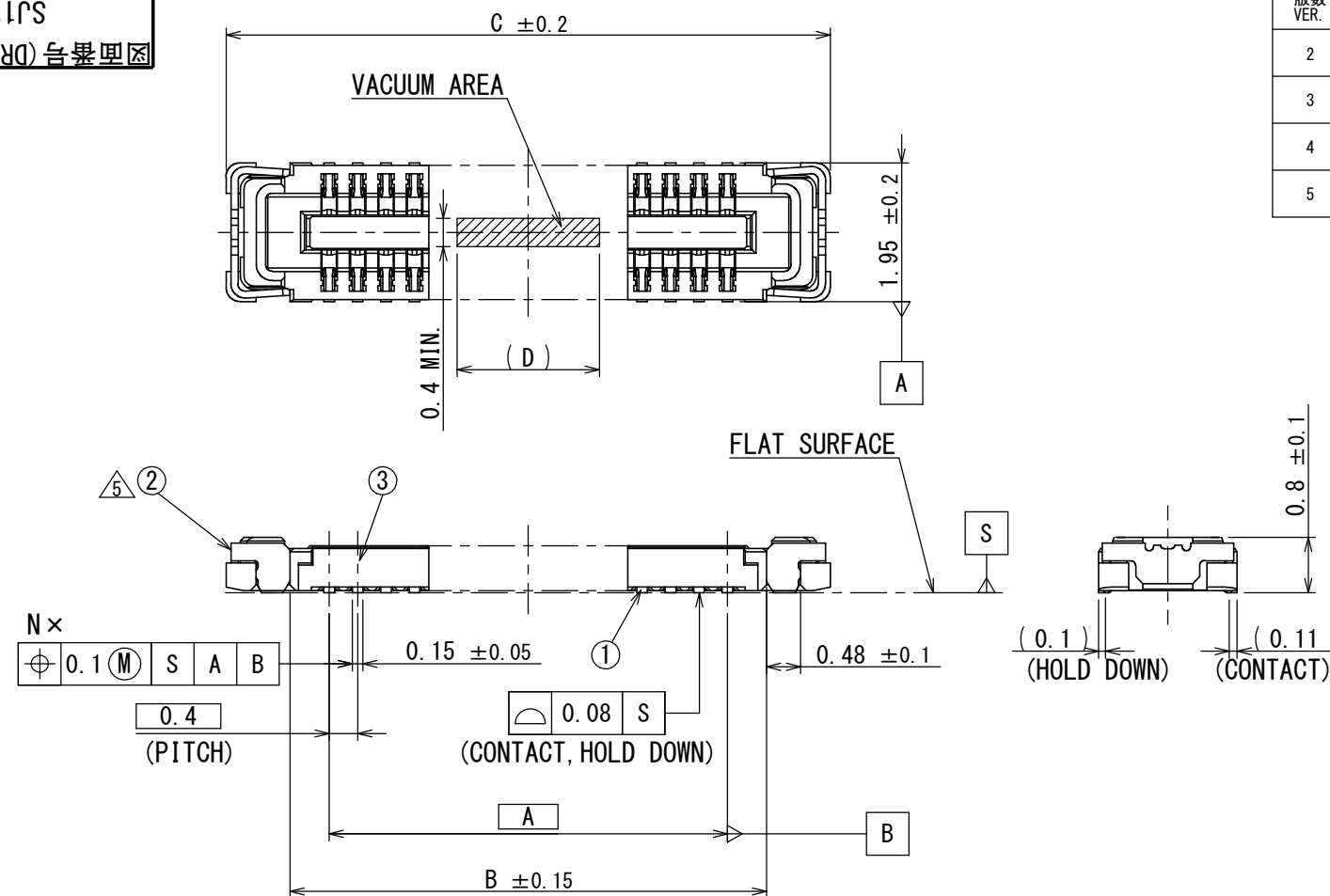
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版数 VER.	年月日 DATE	CN NO.	変 更 内 容 DESCRIPTION	製 図 DR.	担 当 CHK.	査 閲 APPD.	承 認 APPD.
2	01/NOV/2011	000719	ADDED ITEM	—	K. NAKATA	T. NISHIMURA	H. OBIKANE
3	2012/08/08	003622	ADDED ITEM	—	K. NAKATA	T. NISHIMURA	H. OBIKANE
4	13/FEB/2013	005363	ADDED ITEM	—	Y. TAKENAGA	T. NISHIMURA	H. OBIKANE
5	16/DEC/2013	008381	CORRECT AN ERROR	Y. MORI	T. OMODACHI	T. NISHIMURA	H. OBIKANE



	N (PIN)	A	B	C	D	E
	10	1.6	2.7	4.5	2.0	2.4
	14	2.4	3.5	5.3	2.0	3.2
	20	3.6	4.7	6.5	2.0	4.4
	24	4.4	5.5	7.3	2.0	5.2
	30	5.6	6.7	8.5	5.0	6.4
	32	6.0	7.1	8.9	5.0	6.8
	40	7.6	8.7	10.5	5.0	8.4
	60	11.6	12.7	14.5	5.0	12.4

3	INSULATOR インシュレータ	1	HEAT RESISTING PLASTICS 耐熱プラスチック	—	—
2	HOLD DOWN ホールドダウン	2	COPPER ALLOY 銅合金	TIN PLATING Snめっき	—
1	CONTACT コンタクト	N	COPPER ALLOY 銅合金	GOLD PLATING OVER NICKEL Ni上Auめっき	CONTACT AREA: GOLD (0.1 μmMIN) TERMINAL AREA: GOLD (0.05 μmMIN)
符号 NO.	名 称 DESCRIPTION	個 数 QTY.	材 料 MATERIAL	仕 上 FINISH	備 考 REMARKS
仕様書 (SPECIFICATION) JACS-10819-*			第1版 (ORIGINAL DATE) 28/JUN/2011		JAE-CONNECTOR.CO Reference Only 日本航空電子工業株式会社  JAPAN AVIATION ELECTRONICS INDUSTRY, LTD.
			製図 DR.	—	
一般公差 (GENERAL TOLERANCE)			担当 CHK.	K. NAKATA	
			査閲 APPD.	T. NISHIMURA	
寸法 (DIMENSION)			承認 APPD.	H. OBIKANE	
			質量 (MASS) —		
. ±0.8 . × ±0.4 . × × ±0.1 . × × × ±			. シリーズ (SERIES) WP9 名称 (TITLE) WP9-S***VA1 		図面番号 (DRAWING NO.) SJ111861
. 角度 (ANGLES) ×° ± ×°×' ± 単位 (UNIT) : mm					